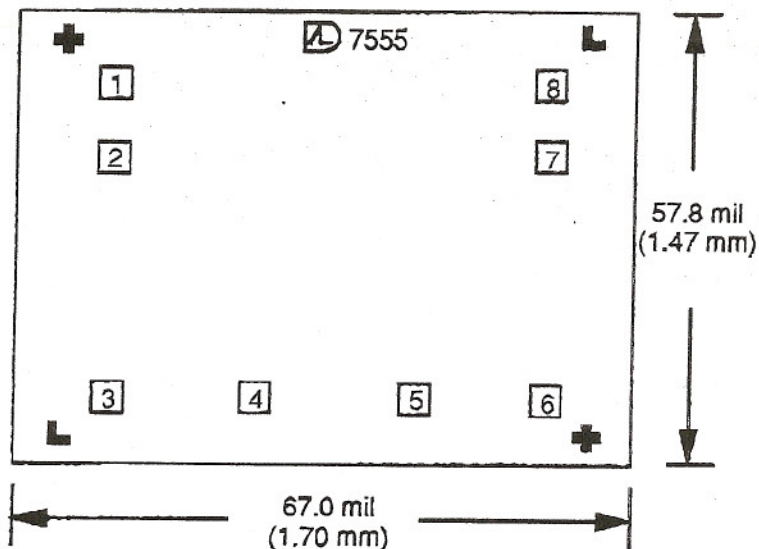




Sierra Components, Inc.

2222 Park Place Building 3 Suite E • Minden, Nevada 89423
Phone: 775.783.4940 Fax: 775.783.4947



Notes:

- 1) Not to scale
- 2) Die Marking: 7555
- 3) Substrate must be connected to V+
- 4) All other pads must be left open with NO CONNECTION.

Topside Metal: Aluminum
Backside: Silicon
Backside Potential: See Above
Mask Ref:
Bond Pads: .004" Min.

APPROVED BY:
MFG: Advanced Linear Devices

DIE SIZE: .058" X .067"
THICKNESS: .010 ± .003"

DATE: 6/15/01
P/N: ICM7555

DG 10.1.2
Rev A 3-4-99